

Temperature Controlled and Microprocessor Managed Soldering-De-Soldering Station Mod. ABS- 961

Supply:	220V (+/- 10%) 50Hz
Max. Total Absorption:	180W
Fuses:	2 fuses 5x20 T 1,6 A
Soldering Handle:	24V – 48W
De-Soldering Handle:	24V – 55W
Weight:	8,300 Kg.
Dimensions:	L 30 cm. - H 12,5 cm – Depth 23,2 cm
Temperature:	from 100°C to 400°C
Interface RS232:	9 pin "IN" RS232 male connector / 9 pin "OUT" RS232 female connector
Equipotential socket:	Ø 4 mm bush



Strengthened Temperature Controlled and Microprocessor Managed Soldering-De-soldering Station Mod. ABS 961A

Supply:	220V (+/- 10%) 50Hz
Max. total absorption:	205W
Fuses:	2 fuses- 5x20 T 2 A
Soldering Handle:	24V – 48W
De-soldering Handle:	24V – 75W
Weight:	8,300 Kg.
Dimensions:	L 30 cm. - H 12,5 cm – Depth 23,2 cm
Temperature:	from 100°C to 400°C
RS232 Interface:	9 pin "IN" RS232 male connector/9 pin "OUT" RS232 female connector
Equipotential socket:	Ø 4 mm bush



Temperature Controlled Analogue Soldering-De-soldering Station Mod. ABS 18

Supply:	220V (+/- 10%) 50Hz
Max. total absorption:	180W
Fuses:	2 fuses 5x20 T 1,6 A
Soldering Handle:	24V-48W
De-Soldering Handle:	24V-55W
Weight:	8 Kg.
Dimensions:	31 cm. L x 13 cm. H x 21 cm D
Temperature:	from 200°C to 400°C

